



THERMAL SYSTEMS

Press information

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Rehm's first trade fair appearances in Germany

Rehm Thermal Systems takes part in Bondexpo and productronica

Here we go again! After trade fairs have already taken place in China and Russia in recent months, the first trade fairs in Germany at which Rehm Thermal Systems will be taking part are now coming up: Bondexpo in Stuttgart and productronica in Munich. The Rehm team is already looking forward to your visit!

Bondexpo is regarded as the leading trade fair for bonding technology and is an important industry meeting place for all aspects of industrial joining and bonding. From 5 to 8 October, exhibitors will be presenting themselves at the Stuttgart exhibition centre, including Rehm Thermal Systems with its product portfolio in the areas of dispensing, bonding technologies and application processes. With the clear and consistent focus of Bondexpo on the joining/compounding process chain through bonding, potting, sealing and foaming, economical detailed and system solutions will be offered for the current and future challenges in the area of joining and compounding a wide variety of materials.

Rehm Thermal Systems GmbH
Leinenstraße 7
89143 Blaubeuren-Seissen

Press contact:

Anna-Lena Hoffmann
Phone: +49 73 44-96 06 746
Fax: +49 73 44-96 06 525
an.hoffmann@rehm-group.com
www.rehm-group.com





Images are attached: Pictures from past trade fair appearances at Bondexpo and productronica (Photos: Rehm Thermal Systems).

The electronics industry is constantly facing new challenges in the processing of sensitive electronic components: Rehm Thermal Systems offers suitable solutions and systems for these requirements, which will be presented at productronica in Munich. The world's leading trade fair for the development and production of electronics will take place this year from 16 to 19 November at the exhibition centre in Munich.

You will receive more information about the systems that will be presented at Bondexpo and productronica at a later date. We are looking forward to welcoming you at our booth in Stuttgart and Munich!

About Rehm Thermal System

As a specialist in the field of thermal system solutions for the electronics and photovoltaics industries, Rehm is a technology and innovation leader in the modern and economical production of electronic modules. As a globally operating manufacturer of reflow soldering systems with convection, condensation or vacuum, drying and coating systems, functional test systems, equipment for the metallization of solar cells as well as numerous customer-specific special systems, we are represented in all relevant growth markets and, as a partner with more than 30 years of industry experience, we implement innovative manufacturing solutions that set standards.